

# 2017-2025 World Semiconductor Advanced Packaging Market Research Report (by Product Type, End-User/Application and Regions/Countries)

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## Abstracts

### SUMMARY

This report includes market status and forecast of global and major regions, with introduction of vendors, regions, product types and end industries; and this report counts product types and end industries in global and major regions.

The report includes as follows:

The report provides current data, historical overview and future forecast.

The report includes an in-depth analysis of the Global market for Semiconductor Advanced Packaging , covering Global total and major region markets.

The data of 2017-2025 are included. All-inclusive market are given through data on sales, consumption, and prices (Global total and by major regions).

The report provides introduction of leading Global manufacturers.

Semiconductor Advanced Packaging market prospects to 2025 are included (in sales, consumption and price).

Market Segment as follows:

By Region / Countries

North America (U.S., Canada, Mexico)

Europe (Germany, U.K., France, Italy, Russia, Spain etc)

Asia-Pacific (China, India, Japan, Southeast Asia etc)

South America (Brazil, Argentina etc)

Middle East & Africa (Saudi Arabia, South Africa etc)

### By Type

FO WLP

2.5D/3D

FI WLP

Flip Chip

### By End-User / Application

CMOS image sensors

Wireless connectivity devices

Logic and memory devices

MEMS and sensors

Analog and mixed ICs

### By Company

Advanced Semiconductor Engineering

Amkor Technology

Samsung Semiconductor

TSMC

China Wafer Level CSP

ChipMOS TECHNOLOGIES

FlipChip International

HANA Micron

Interconnect Systems (Molex)

Jiangsu Changjiang Electronics Technology (JCET)

King Yuan Electronics

Tongfu Microelectronics

Nepes

Powertech Technology (PTI)

SIGNETICS

Tianshui Huatian

Ultratech

UTAC

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